



SY89871U

2.5GHz Any Diff. In-To-LVPECL Programmable Clock Divider/Fanout Buffer w/ Internal Termination



Precision Edge®

General Description

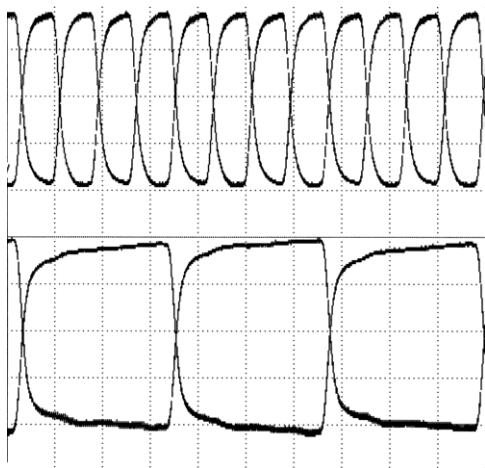
The SY89871U is a 2.5V/3.3V LVPECL output precision clock divider capable of accepting a high-speed differential clock input (AC or DC-coupled) CML, LVPECL, HSTL or LVDS clock input signal and dividing down the frequency using a programmable divider ratio to create a frequency-locked lower speed version of the input clock (Bank B). Available divider ratios are 2, 4, 8, and 16. In a typical 622MHz clock system this would provide availability of 311MHz, 115MHz, 77MHz, or 38MHz auxiliary clock components.

The differential input buffer has a unique internal termination design that allows access to the termination network through a VT pin. This feature allows the device to easily interface to different logic standards. A V_{REF-AC} reference is included for AC-coupled applications.

The SY89871U includes two phase-matched output banks. Bank A (QA) is a frequency-matched copy of the input. Bank B (QB0, QB1) is a divided down output of the input frequency. Bank A and Bank B maintain a matched delay independent of the divider setting.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Typical Performance



United States Patent No. RE44,134

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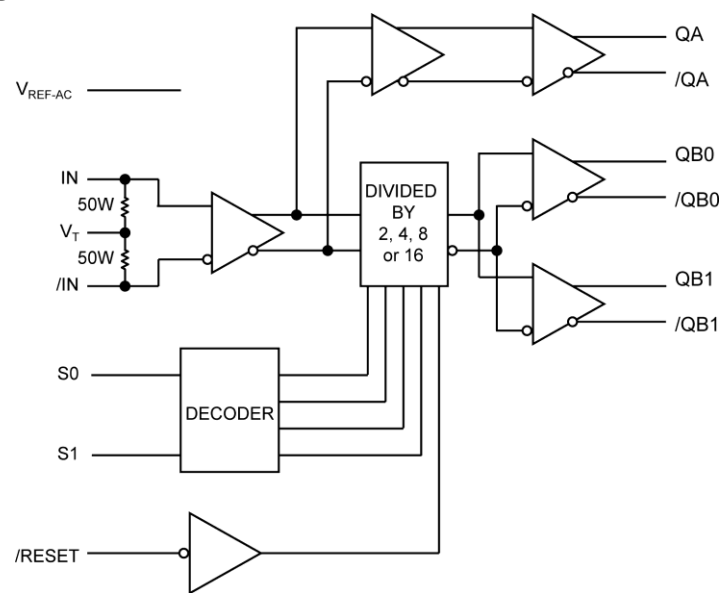
Features

- Two matched-delay outputs:
 - Bank A: undivided pass-through (QA)
 - Bank B: programmable divide by 2, 4, 8, 16 (QB0, QB1)
- Matched delay: all outputs have matched delay, independent of divider setting
- Guaranteed AC performance:
 - $>2.5\text{GHz } f_{MAX}$
 - $<250\text{ps } t_r/t_f$
 - $<670\text{ps } t_{pd}$ (matched delay)
 - $<15\text{ps}$ within-device skew
- Low jitter design
 - 231fs RMS phase jitter (Typ)
- Power supply 3.3V or 2.5V
- Unique patent-pending input termination and VT pin for DC- and AC- coupled inputs: any differential inputs (LVPECL, LVDS, CML, HSTL)
- TTL/CMOS inputs for select and reset
- 100K EP compatible LVPECL outputs
- Parallel programming capability
- Wide operating temperature range: -40°C to $+85^{\circ}\text{C}$
- Available in 16-pin (3mm x 3mm) QFN package

Applications

- OC-3 to OC-192 SONET/SDH applications
- Transponders
- Oscillators
- SONET/SDH line cards

Functional Block Diagram

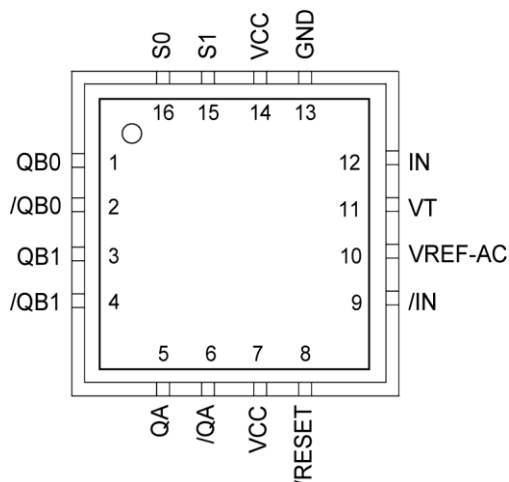


Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89871UMG ⁽²⁾	QFN-16	Industrial	871U with Pb-Free bar line indicator	NiPdAu Pb-Free
SY89871UMGTR ^(1,2)	QFN-16	Industrial	871U with Pb-Free bar line indicator	NiPdAu Pb-Free

- Note:**
1. Contact factory for die availability. Dice are guaranteed at TA = 25°C, DC Electricals only.
 2. Tape and Reel.

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Function
1, 2, 3, 4	QB0, /QB0 QB1, /QB1	Differential Buffered Output Clocks: The differential output is a divided-down version of the input frequency and has a matched output delay with Bank A. Divided by 2, 4, 8, or 16. See "Truth Table." Unused output pairs may be left floating.
5, 6	QA, /QA	Differential Buffered Undivided Output Clock.
7, 14	VCC	Positive Power Supply: Bypass with 0.1μF and 0.01μF low ESR capacitors.
8	/RESET	Output Reset: Internal 25KΩ pull-up. Logic LOW will reset the divider select. See "Truth Table." Input threshold is $V_{CC}/2$.
12, 9	IN, /IN	Differential Input: Internal 50Ω termination resistors to VT input. See "Input Interface Applications" section.
10	VREF-AC	Reference Voltage: Equal to $V_{CC}-1.4V$ (approx.), and used for AC-coupled applications. For DC-coupled applications, VREF-AC is normally left floating. Maximum sink/source current is 0.5mA. See "Input Interface Applications" section.
11	VT	Input Termination Center-Tap: Each side of differential input pair terminates to this pin. The VT pin provides a center tap to a termination network for maximum interface flexibility. For CML and LVDS inputs, leave this pin floating. See "Input Interface Application" section.
13	GND	Ground.
15, 16	S1, S0	Select Pins: See "Truth Table." LVTTTL/CMOS logic levels. Internal 25KΩ pull-up resistor. Logic HIGH if left unconnected (divided by 16 mode). S0 = LSB. Input threshold is $V_{CC}/2$.

Truth Table

/RESET	S1	S0	Bank A Output	Bank B Outputs
1	0	0	Input Clock	Input Clock ÷ 2
1	0	1	Input Clock	Input Clock ÷ 4
1	1	0	Input Clock	Input Clock ÷ 8
1	1	1	Input Clock	Input Clock ÷ 16
0	X	X	Input Clock	QB = LOW, /QB = HIGH

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})	–0.5V to +4.0V
Input Voltage (V_{IN})	–0.5V to $V_{CC}+0.3V$
PECL Output Current (I_{OUT})	
Continuous	50mA
Surge	100mA
V_T Current (I_{VT})	$\pm 100mA$
Input Current I_N , $/I_N$ (I_{IN})	$\pm 50mA$
R_{REF-AC} Sink/Source Current ($I_{VREF-AC}$)	$\pm 2mA$
Lead Temperature (soldering, 20 sec.)	260°C
Storage Temperature (T_S)	–65°C to 150°C

Operating Ratings⁽²⁾

Supply Voltage (V_{CC})	+2.375V to +3.63V
Ambient Temperature (T_A)	–40°C to +85°C
Package Thermal Resistance ⁽³⁾	
QFN (θ_{JA})	
Still-Air	60°C/W
500lfpm	54°C/W
QFN (ψ_{JB})	
Junction-to-board	38°C/W

DC Electrical Characteristics⁽⁴⁾

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage		2.37		3.60	V
I_{CC}	Power Supply Current	No load, max V_{CC} .		50	75	mA
R_{IN}	Differential Input Resistance, (IN-to-/IN)		90	100	110	Ω
V_{IH}	Input HIGH Voltage, (IN-to-/IN)		0.1		$V_{CC}+0.3$	V
V_{IL}	Input LOW Voltage, (IN-to-/IN)		–0.3		$V_{IH}-0.1$	V
V_{IN}	Input Voltage Swing	Note 5	0.1		V_{CC}	V
V_{DIFF_IN}	Differential Input Voltage Swing	Notes 5, 6	0.2			V
$ I_{IN} $	Input Current, (IN-to-/IN)	Note 7			45	mA
V_{REF_AC}	Reference Voltage		$V_{CC}-1.525$	$V_{CC}-1.425$	$V_{CC}-1.325$	V

Notes:

1. Permanent device damage may occur if ratings in the "Absolute Maximum Ratings" sections are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Junction-to-board resistance assumes exposed pad is soldered (or equivalent) to the device's most Negative potential on the PCB.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
5. See "Timing Diagram" for V_{IN} definition. V_{IN} (max.) is specified when V_T is floating.
6. See "Typical Operating Characteristics" section for V_{DIFF} definition.
7. Due to the internal termination (see "Input Buffer Structure" section) the input current depends on the applied voltages at I_N , $/I_N$ and V_T inputs. Do not apply a combination of voltages that causes the input current to exceed the maximum limit.

(100KEP) LVPECL DC Electrical Characteristics⁽⁸⁾

$V_{CC} = 3.3V \pm 10\%$ or $2.5V \pm 5\%$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$, $R_L = 50\Omega$ to $V_{CC} - 2V$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	Output HIGH Voltage		$V_{CC} - 1.145$	$V_{CC} - 1.020$	$V_{CC} - 0.895$	V
V_{OL}	Output LOW Voltage		$V_{CC} - 1.945$	$V_{CC} - 1.820$	$V_{CC} - 1.695$	V
V_{OUT}	Output Voltage Swing		550	800	1050	mV
V_{DIFF_OUT}	Differential Output Voltage Swing		1.10	1.6	2.1	V

LVTTTL/ LVCMOS DC Electrical Characteristics⁽⁸⁾

$V_{CC} = 3.3V \pm 10\%$ or $2.5V \pm 5\%$; $T_A = -40^{\circ}C$ to $+85^{\circ}C$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{IH}	Input HIGH Voltage		2.0			V
V_{IL}	Input LOW Voltage				0.8	V
I_{IH}	Input HIGH Current		-125		20	μA
I_{IL}	Input LOW Current				-300	μA

Note:

8. The circuit is designed to meet the DC specification s shown in the above table after thermal equilibrium has been established. Parameters are for $V_{CC} = 2.5V$. They vary 1:1 with V_{CC} .

AC Electrical Characteristics⁽⁹⁾

$V_{CC} = 3.3V \pm 10\%$ or $2.5V \pm 5\%$; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Output Toggle Frequency	Output Swing $\geq 400mV$	2.5			GHz
	Maximum Input Frequency	Note 10	3.2			GHz
t_{PD}	Differential Propagation Delay IN-to_QA or QB	Input Swing $< 400mV$	460	580	710	ps
		Input Swing $\geq 400mV$	420	550	670	ps
t_{SKEW}	Within-Device Skew (Differential) QB0-to-QB1	Note 11		7	15	ps
	Within-Device Skew (Differential) QA-to-QB	Note 11		12	30	ps
	Part-to-Part Skew (Differential)	Note 11			250	ps
t_{JITTER}	RMS Phase Jitter	Output = 622MHz Integration Range 1.875MHz – 20MHz		231		fs
t_{RR}	Reset Recovery Time		600			Ps
t_r, t_f	Output Rise/Fall Times (20% to 80%)		70	150	250	ps

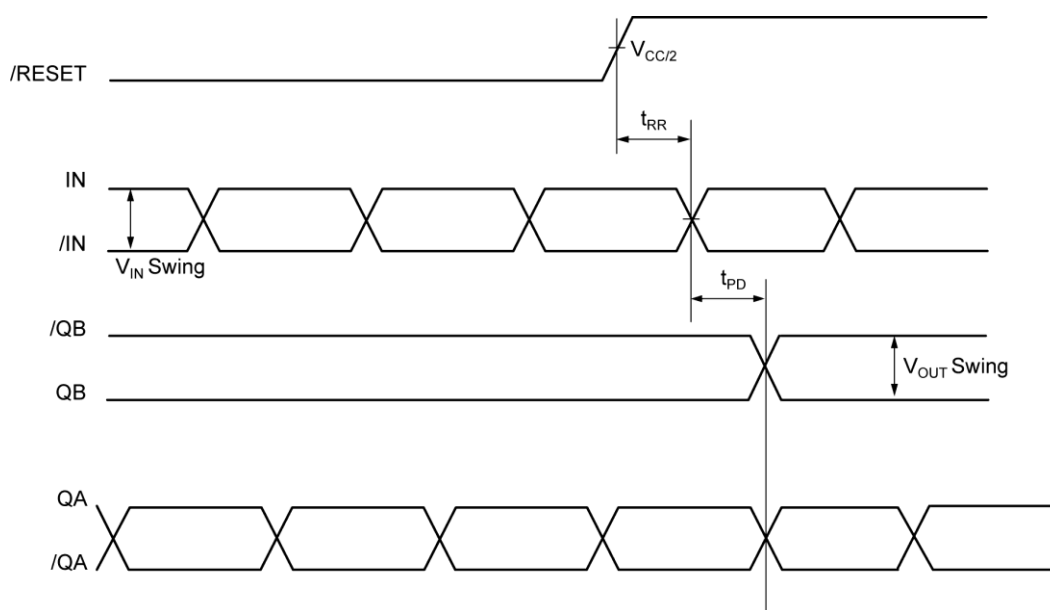
Notes:

9. Measured with 400mV input signal, 50% duty cycle, all loading with 50Ω to $V_{CC}-2V$, unless otherwise stated.

10. Bank A (pass-through) maximum frequency is limited by the output stage. Bank B (input-0to-input $\div 2, \div 4, \div 8, \div 16$) can accept an input frequency $>3GHz$, while Bank A will be slew rate limited.

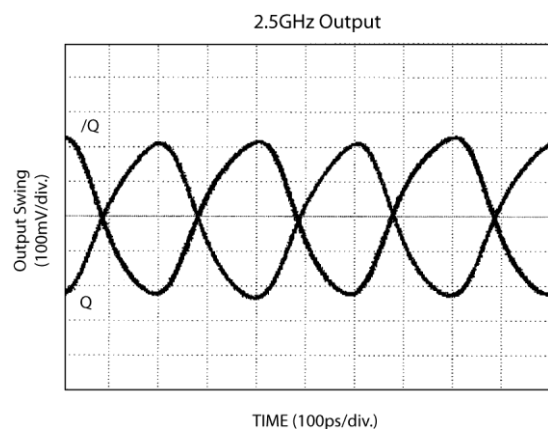
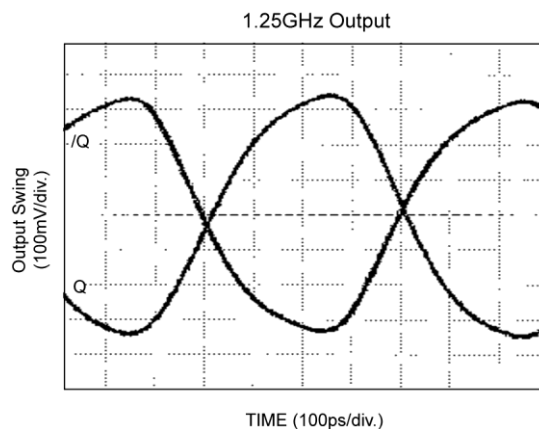
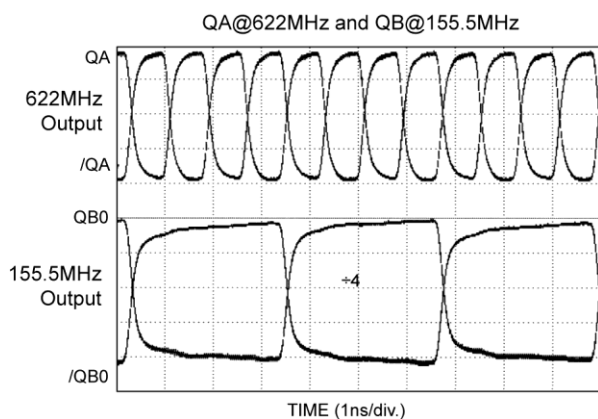
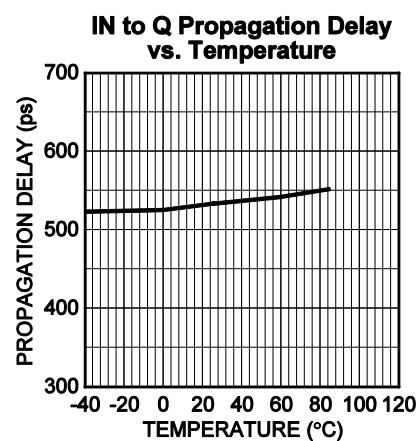
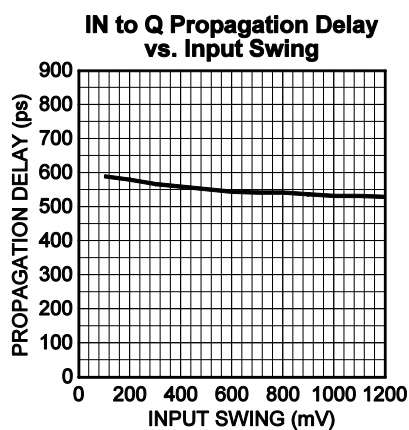
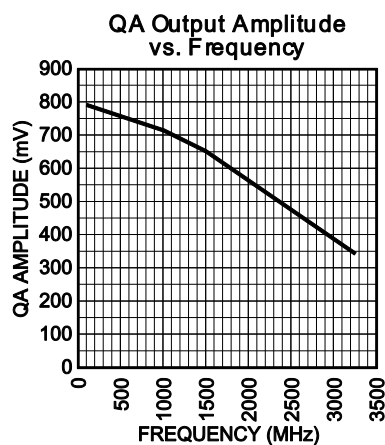
11. Skew is measured between outputs under identical transitions.

Timing Diagram



Typical Operating Characteristics

$V_{CC} = 3.3V$, $V_{IN} = 400mV$, $T_A = 25^\circ C$, $R_L = 50\Omega$ to $V_{CC}-2V$, unless otherwise stated.



Definition of Single-Ended and Differential Swing

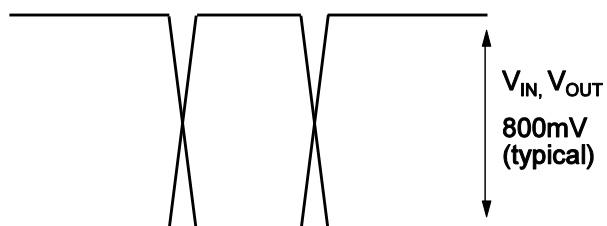


Figure 1a. Single-Ended Swing

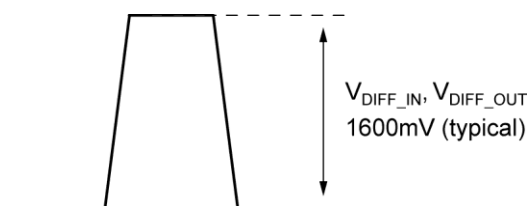


Figure 1b. Differential Swing

Input Buffer Structure

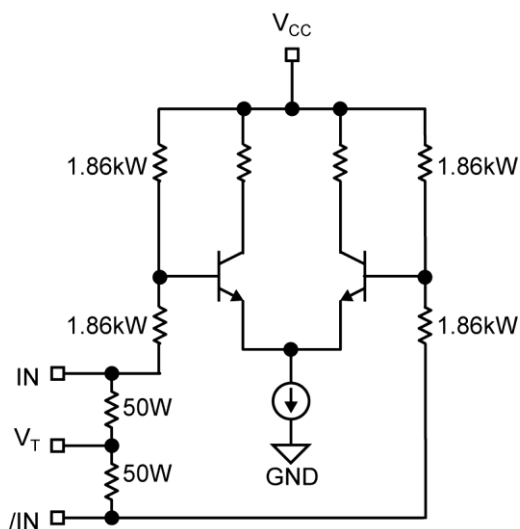


Figure 2a. Simplified Differential Input Buffer

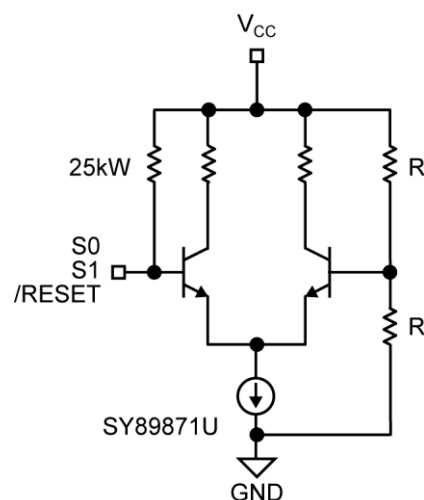


Figure 2b. Simplified TTL/CMOS Input Buffer

Input Interface Applications

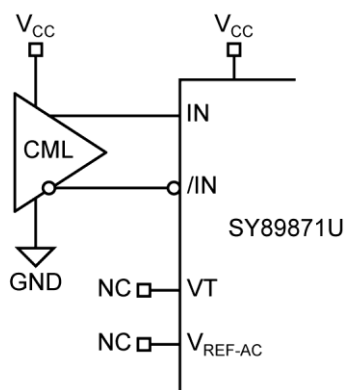


Figure 3a. DC-Coupled CML Input Interface

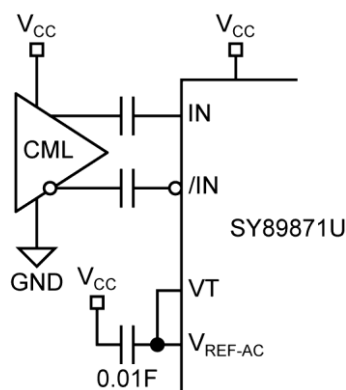


Figure 3b. AC-Coupled CML Input Interface

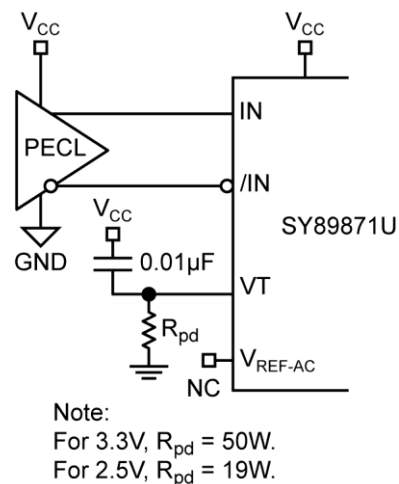


Figure 3c. DC-Coupled PECL Input Interface

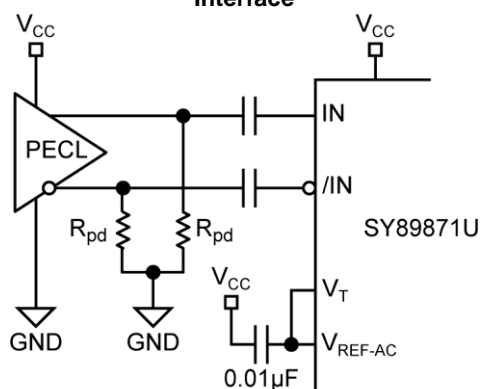


Figure 3d. AC-Coupled PECL Input Interface

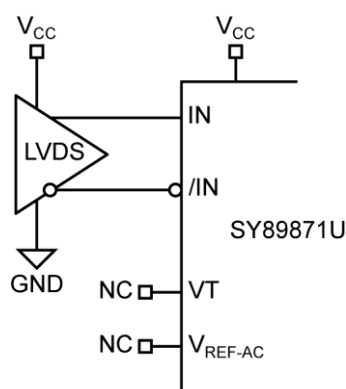


Figure 3e. LVDS Input Interface

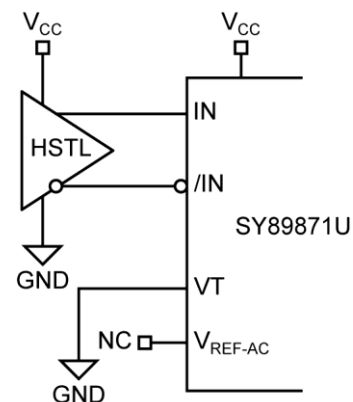


Figure 3f. HSTL Input Interface

Related Product and Support Documentation

Part Number	Function	Data Sheet Link
SY89874U	2.5GHz Any Diff. In-to-LVPECL Programmable Clock Divider and 1:2 Fanout Buffer w/Internal Termination	http://www.micrel.com/product-info/products/sy8987u.shtml
HBW Solutions	New Products and Applications	http://www.micrel.com/product-info/products/solutions.shtml

LVPECL Output Termination Recommendations

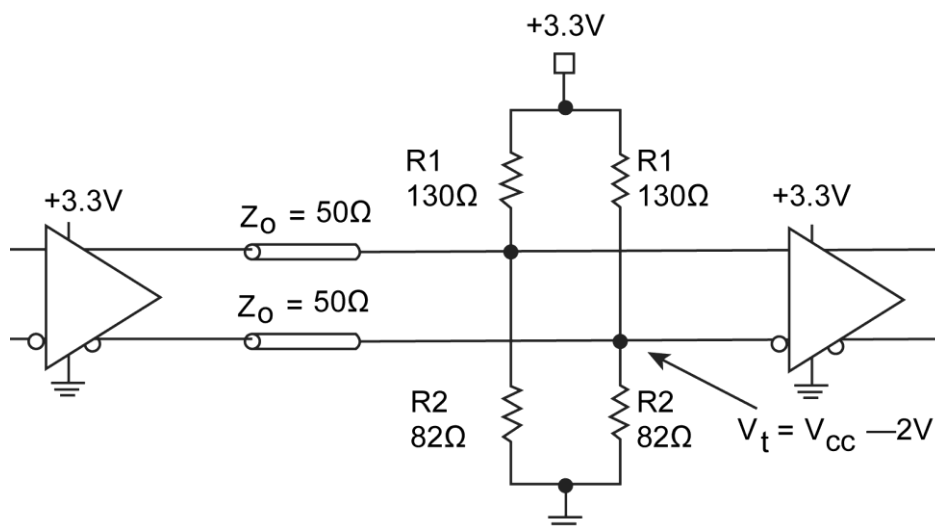


Figure 4a. Parallel Termination-Thevenin Equivalent

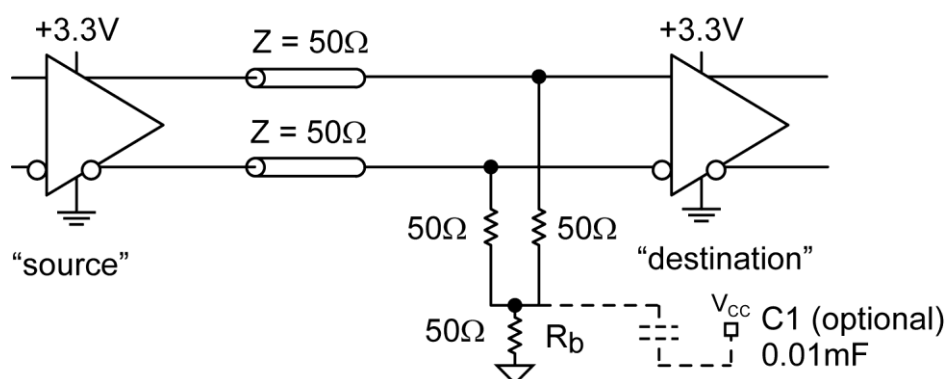


Figure 4b. Three-Resistor "Y-Termination"

Notes:

1. Power-saving alternative to Thevenin termination.
2. Place termination resistors as close to destination inputs as possible.
3. R_b resistor sets the DC bias voltage, equal to V_T . For +3.3V systems $R_b = 46\Omega$ to 50Ω . For +2.5V systems $R_b = 19\Omega$.
4. C1 is an optional bypass capacitor intended to compensate for any t_r/t_f mismatches.

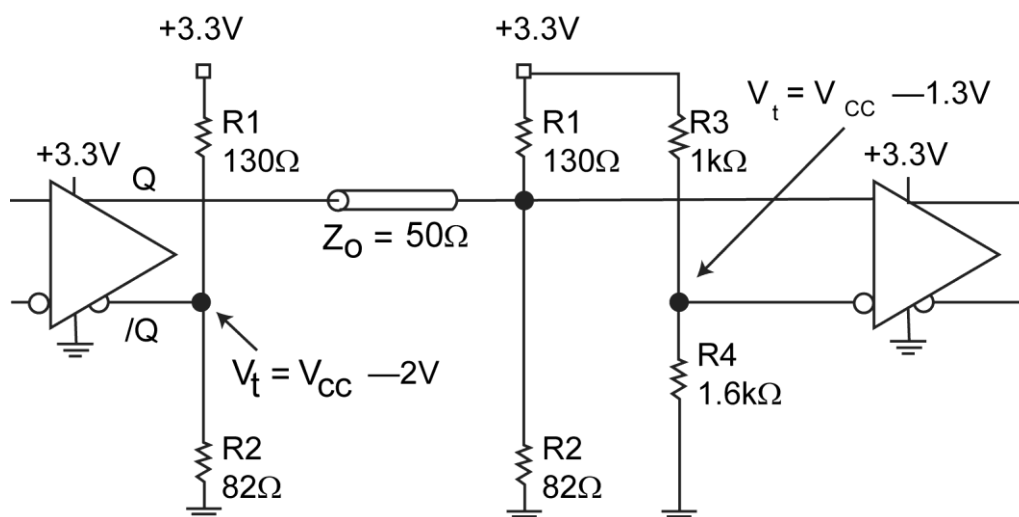
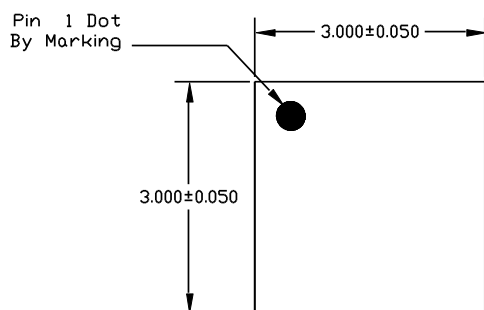


Figure 4c. Terminating Unused I/O

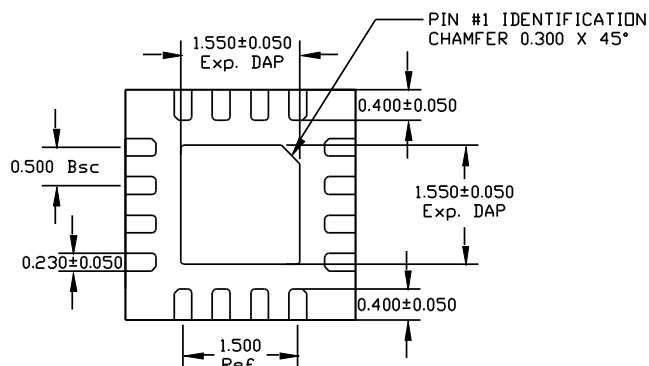
Notes:

1. Unused output (/Q) must be terminated to balance the output.
2. For +2.5V systems: R1 = 250Ω, R2 = 62.5Ω, R3 = 1.25kΩ, R4 = 1.2kΩ.

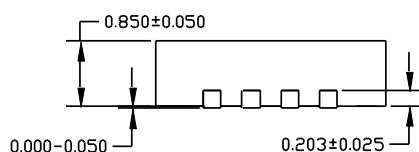
Package Information



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.

16-Pin Package Type (QFN)

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Revision Template History

Date	Change Description/Edits by:	Rev.
8/4/10	Added new paragraph to disclaimer in boiler plate. Per Colin Sturt. M.Galvan	14

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